

**RECEIVED
CENTRAL FAX CENTER****MAR 13 2007****IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Applicant(s): Liu

Application No.: 10/634,964

Filed: 8/5/2003

Title: CHEMICAL MECHANICAL
PLANARIZATION COMPOSITIONS FOR
REDUCING EROSION IN SEMICONDUCTOR
WAFERSArt Unit:
1765Examiner:
Patricia A. George

Attorney Docket No.: 02039US

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450**RESPONSE AFTER FINAL REJECTION**

Dear Sir:

In response to the Office Action of February 5, 2007, having a shortened statutory
deadline of May 5, 2007, please amend the specification as follows.

PLEASE
ENTER
8/27/07
[Signature]